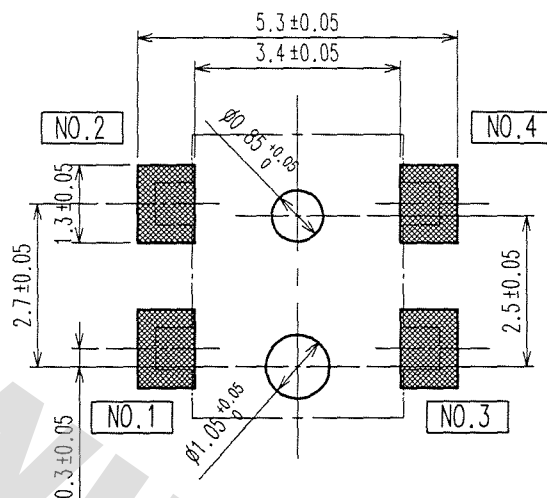
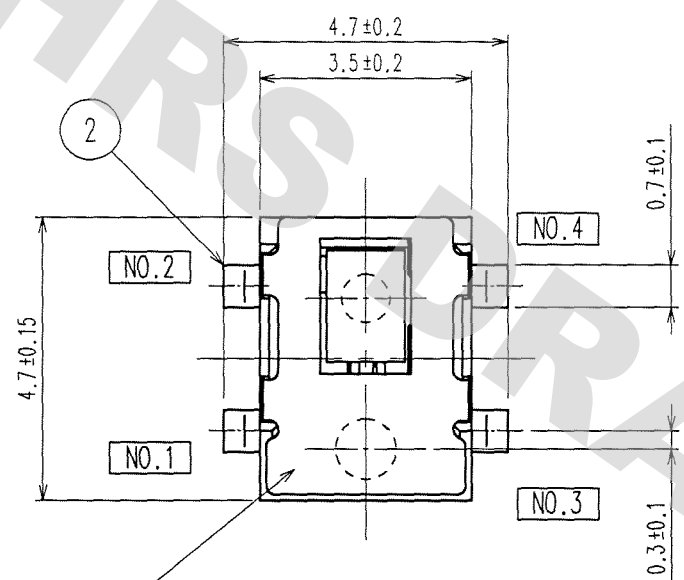
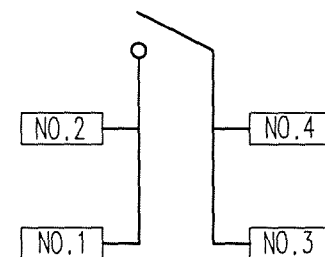


ELV RoHS



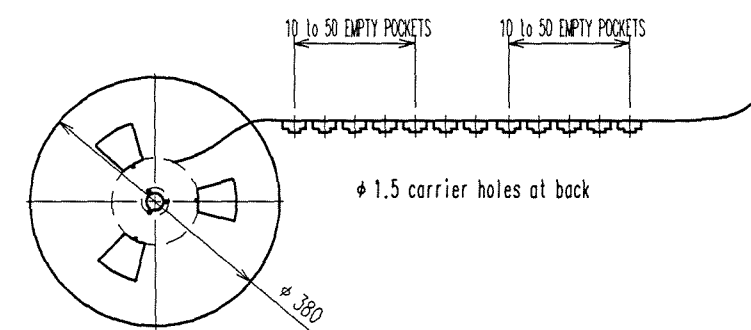
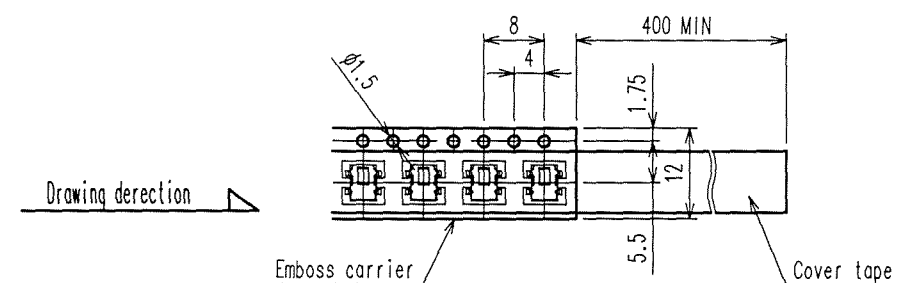
Recommended PC board pattern.



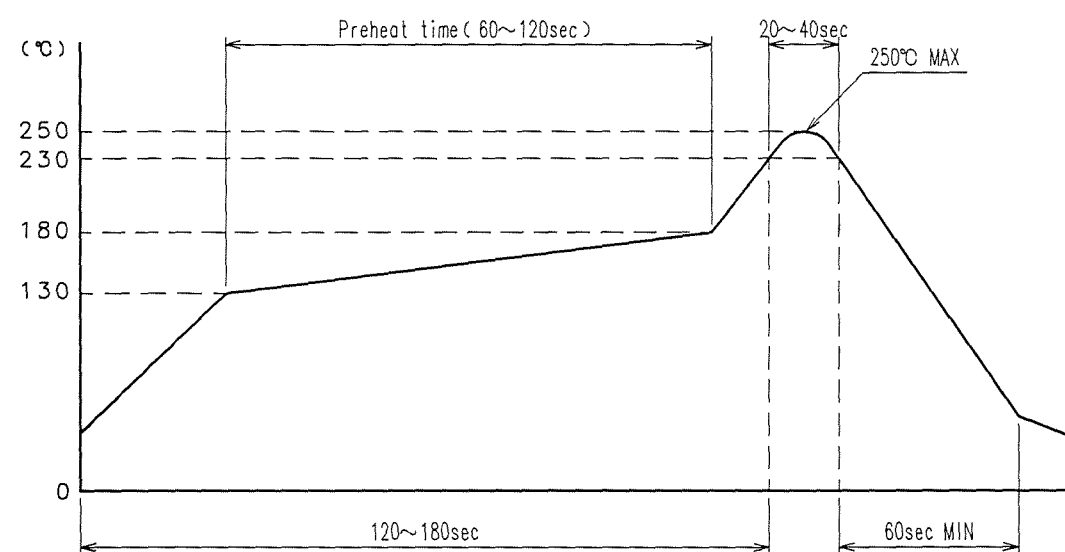
Circuit drawing

Emboss speculation

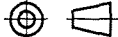
1. Emboss tape fixing force is 0.1N to 0.7N.
2. 2500 connectors are in one emboss carrier.



Note1 : No of reflow cycles : 2 MAX
2 : Recommended solder thickness = 0.15



Recommended temperture profile for reflow

3	SUS	—	5	Phosphor bronze	Gold plated
2	Copper alloy	Gold plated	4	PA-M	—
1	PPS-M	—			
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD) CL?		DRAWN N.NAKATA 07.6.1	DESIGNED N.NAKATA 07.6.1	CHECKED K.SATO 07.6.1	APPROVED K.SATO 07.6.1
		DRAWING NO. EDC3-166796 GT22-SW			
SCALE 8 : 1		CODE NO. CL772-0004-2			1/
UNITS mm  HIROSE ELECTRIC CO., LTD					

FORM NO. 229